# TIBPAL20L8-5C, TIBPAL20R4-5C, TIBPAL20R6-5C, TIBPAL20R8-5C TIBPAL20L8-7M, TIBPAL20R4-7M, TIBPAL20R6-7M, TIBPAL20R8-7M HIGH-PERFORMANCE IMPACT-X™ PAL® CIRCUITS

SRPS010F - D3353, OCTOBER 1989 - REVISED SEPTEMBER 1992

High-Performance Operation:

f<sub>max</sub> (no feedback)

TIBPAL20R' -5C Series . . . 125 MHz Min

TIBPAL20R' -7M Series . . . 100 MHz Min

f<sub>max</sub> (internal feedback)

TIBPAL20R' -5C Series . . . 125 MHz Min

TIBPAL20R' -7M Series . . . 100 MHz Min

f<sub>max</sub> (external feedback)

TIBPAL20R' -5C Series . . . 117 MHz Min

TIBPAL20R' -7M Series . . . 74 MHz Min

**Propagation Delay** 

TIBPAL20L8-5C Series . . . 5 ns Max

TIBPAL20L8-7M Series . . . 7 ns Max

TIBPAL20R' -5C Series

(CLK-to-Q) . . . 4 ns Max

TIBPAL20R' -7M Series

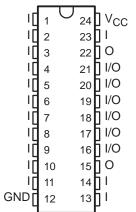
(CLK-to-Q) . . . 6.5 ns Max

- Functionally Equivalent, but Faster Than, Existing 24-Pin PLDs
- Preload Capability on Output Registers Simplifies Testing
- Power-Up Clear on Registered Devices (All Register Outputs are Set Low, but Voltage Levels at the Output Pins Go High)
- Package Options Include Both Plastic and Ceramic Chip Carriers in Addition to Plastic and Ceramic DIPs
- Security Fuse Prevents Duplication

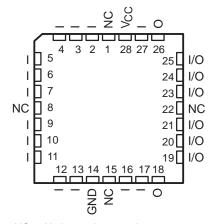
DEVICE	I INPUTS	3-STATE O OUTPUTS	REGISTERED Q OUTPUTS	I/O PORT S
PAL20L8	14	2	0	6
PAL20R4	12	0	4 (3-state buffers)	4
PAL20R6	12	0	6 (3-state buffers)	2
PAL20R8	12	0	8 (3-state buffers)	0

# TIBPAL20L8' C SUFFIX . . . JT OR NT PACKAGE M SUFFIX . . . JT PACKAGE

(TOP VIEW)



TIBPAL20L8'
C SUFFIX . . . FN PACKAGE
M SUFFIX . . . FK PACKAGE
(TOP VIEW)



NC — No internal connectionPin assignments in operating mode

#### description

These programmable array logic devices feature high speed and functional equivalency when compared with currently available devices. These IMPACT-X<sup>TM</sup> circuits combine the latest Advanced Low-Power Schottky technology with proven titanium-tungsten fuses to provide reliable, high-performance substitutes for conventional TTL logic. Their easy programmability allows for quick design of custom functions and typically results in a more compact circuit board.

The TIBPAL20' C series is characterized from 0°C to 75°C. The TIBPAL20' M series is characterized for operation over the full military temperature range of –55°C to 125°C.

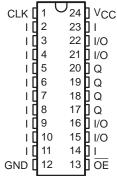
These devices are covered by U.S. Patent 4,410,987. IMPACT-X is a trademark of Texas Instruments Incorporated. PAL is a registered trademark of Advanced Micro Devices Inc.



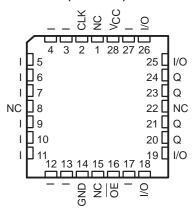
# TIBPAL20R4-5C, TIBPAL20R6-5C, TIBPAL20R8-5C TIBPAL20R4-7M, TIBPAL20R6-7M, TIBPAL20R8-7M HIGH-PERFORMANCE $IMPACT-X^{TM}$ $PAL^{\oplus}$ CIRCUITS

SRPS010F - D3353, OCTOBER 1989 - REVISED SEPTEMBER 1992



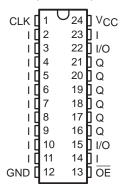


TIBPAL20R4'
C SUFFIX . . . FN PACKAGE
M SUFFIX . . . FK PACKAGE
(TOP VIEW)

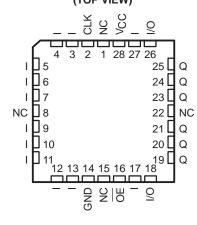


TIBPAL20R6'
C SUFFIX ... JT OR NT PACKAGE
M SUFFIX ... JT PACKAGE

(TOP VIEW)

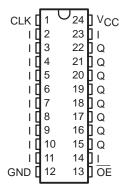


TIBPAL20R6'
C SUFFIX . . . FN PACKAGE
M SUFFIX . . . FK PACKAGE
(TOP VIEW)

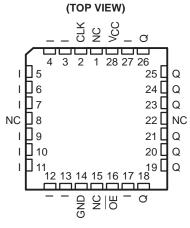


TIBPAL20R8'
C SUFFIX . . . JT OR NT PACKAGE
M SUFFIX . . . JT PACKAGE

(TOP VIEW)



TIBPAL20R8'
C SUFFIX . . . FN PACKAGE
M SUFFIX . . . FK PACKAGE



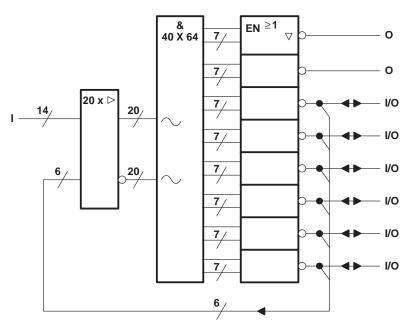
NC - No internal connection

Pin assignments in operating mode

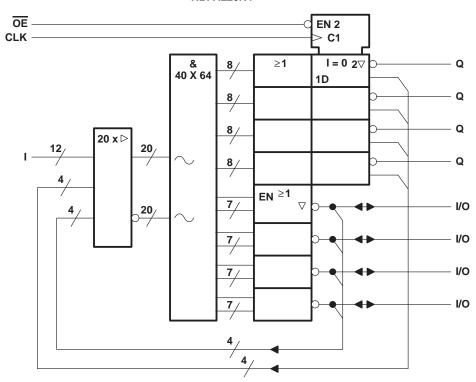


#### functional block diagrams (positive logic)

#### TIBPAL20L8'



#### TIBPAL20R4'



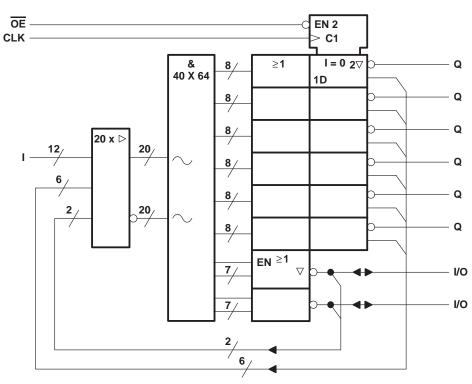
✓ denotes fused inputs



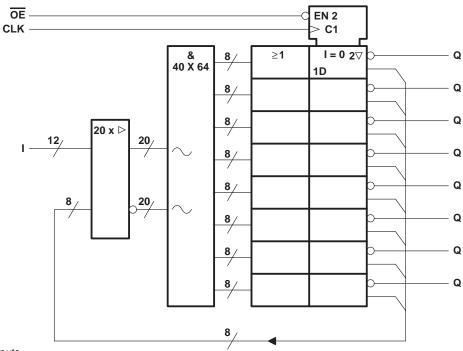
## HIGH-PERFORMANCE IMPACT-X TM PAL® CIRCUITS SRPS010F - D3353, OCTOBER 1989 - REVISED SEPTEMBER 1992

#### functional block diagrams (positive logic)

#### TIBPAL20R6'



#### TIBPAL20R8'



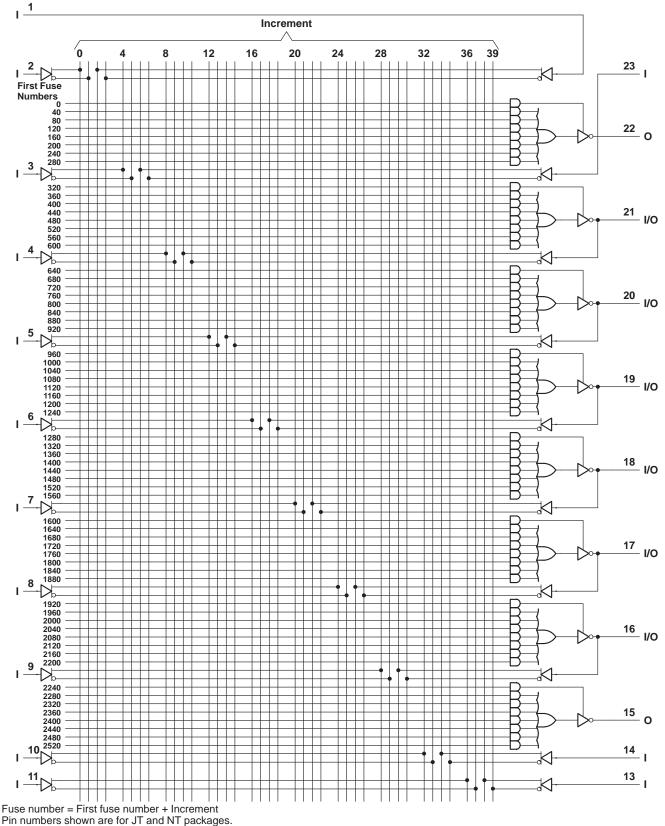
✓ denotes fused inputs



#### HIGH-PERFORMANCE IMPACT-X™ PAL® CIRCUITS

SRPS010F - D3353, OCTOBER 1989 - REVISED SEPTEMBER 1992

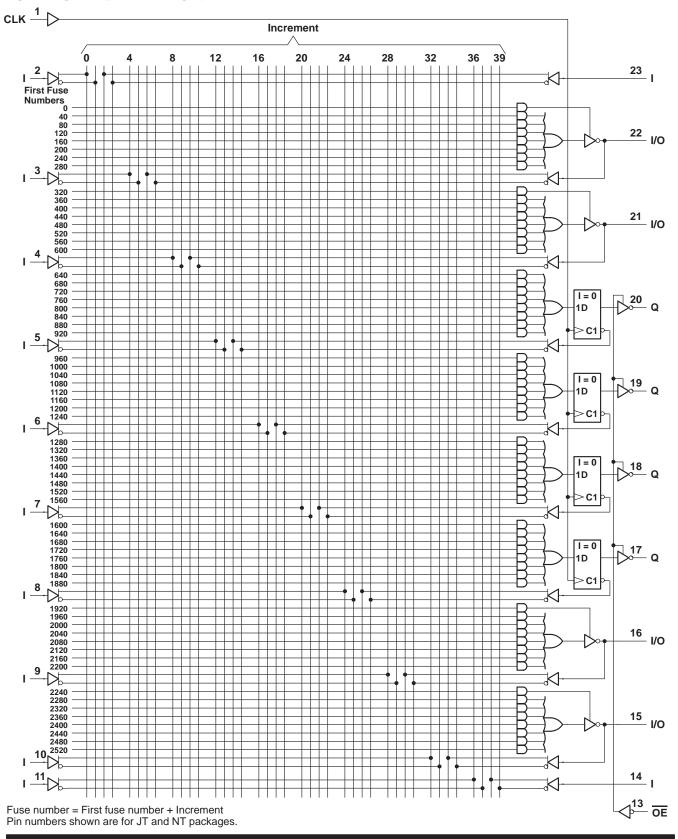
#### logic diagram (positive logic)





## HIGH-PERFORMANCE *IMPACT-X* TM *PAL* ® CIRCUITS SRPS010F – D3353, OCTOBER 1989 – REVISED SEPTEMBER 1992

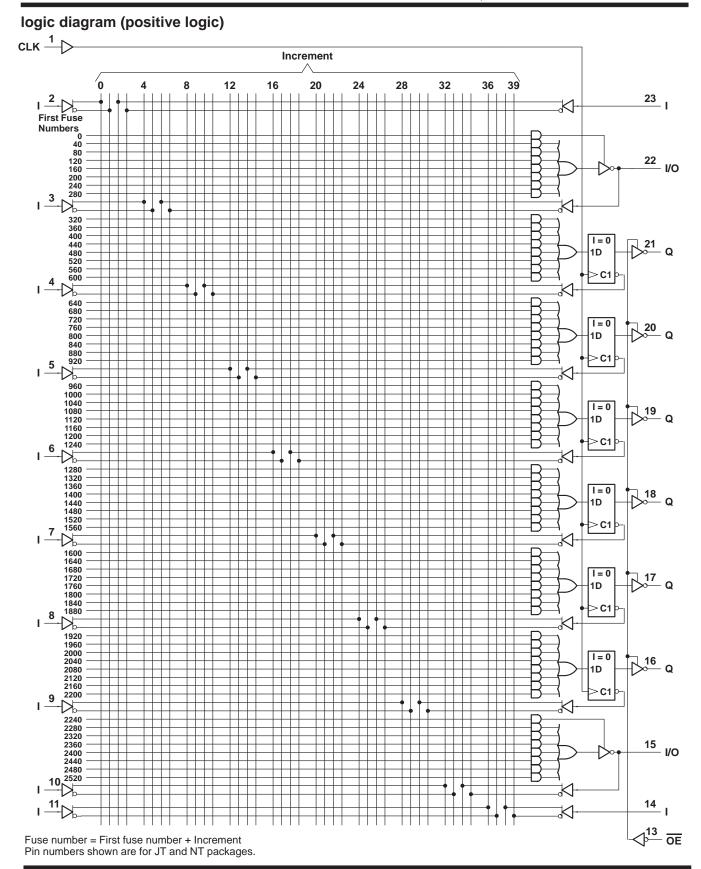
#### logic diagram (positive logic)





#### HIGH-PERFORMANCE IMPACT-X™ PAL® CIRCUITS

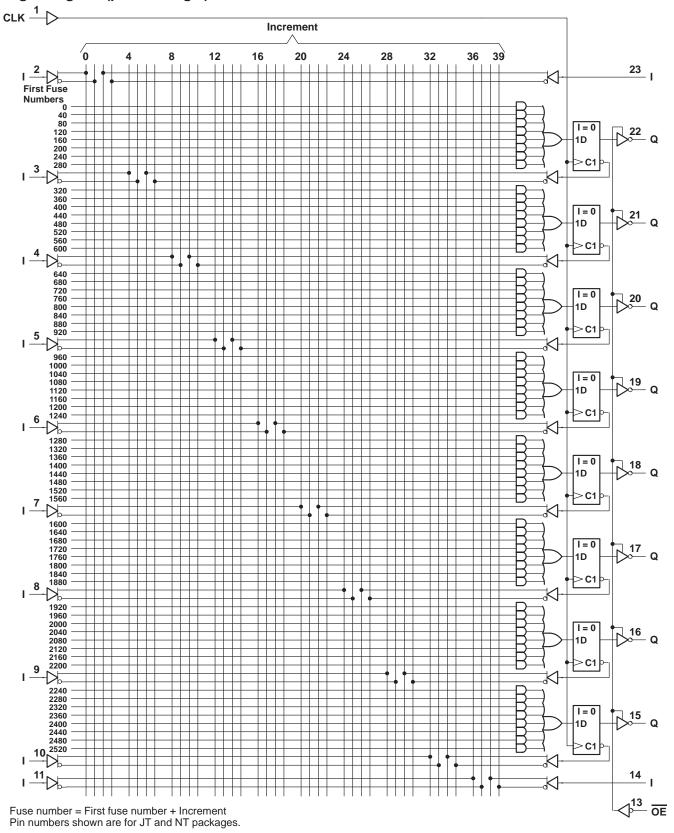
SRPS010F - D3353, OCTOBER 1989 - REVISED SEPTEMBER 1992





## HIGH-PERFORMANCE *IMPACT-X* TM *PAL*® CIRCUITS SRPS010F – D3353, OCTOBER 1989 – REVISED SEPTEMBER 1992

#### logic diagram (positive logic)





#### TIBPAL20L8-5C HIGH-PERFORMANCE *IMPACT-X™ PAL®* CIRCUITS

SRPS010F - D3353, OCTOBER 1989 - REVISED SEPTEMBER 1992

#### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, V <sub>CC</sub> (see Note 1)	7 V
Input voltage (see Note 1)	5.5 V
Voltage applied to disabled output (see Note 1)	5.5 V
Operating free-air temperature range	0°C to 75°C
Storage temperature range	-65°C to 150°C

NOTE 1: These ratings apply except for programming pins during a programming cycle or during a preload cycle.

#### recommended operating conditions

		MIN	NOM	MAX	UNIT
VCC	Supply voltage	4.75	5	5.25	V
VIH	High-level input voltage (see Note 2)	2		5.5	V
VIL	Low-level input voltage (see Note 2)			0.8	V
loh	High-level output current			-3.2	mA
l <sub>OL</sub>	Low-level output current			24	mA
TA	Operating free-air temperature	0	25	75	°C

NOTE 2: These are absolute voltage levels with respect to the ground pin of the device and include all overshoots due to system and/or tester noise. Testing these parameters should not be attempted without suitable equipment.

#### electrical characteristics over recommended operating free-air temperature range

PARAMETER		TEST CONDITIONS		MIN	TYP <sup>†</sup>	MAX	UNIT
VIK	$V_{CC} = 4.75 \text{ V},$	$I_{I} = -18 \text{ mA}$			-0.8	-1.5	V
Voн	$V_{CC} = 4.75 \text{ V},$	$I_{OH} = -3.2 \text{ mA}$		2.4	2.7		V
V <sub>OL</sub>	$V_{CC} = 4.75 \text{ V},$	$I_{OL} = 24 \text{ mA}$			0.3	0.5	V
lozh <sup>‡</sup>	$V_{CC} = 5.25 \text{ V},$	V <sub>O</sub> = 2.7 V				100	μΑ
lozL <sup>‡</sup>	$V_{CC} = 5.25 \text{ V},$	$V_0 = 0.4 \text{ V}$				-100	μΑ
lį	$V_{CC} = 5.25 \text{ V},$	V <sub>I</sub> = 5.5 V				100	μΑ
I <sub>IH</sub> ‡	$V_{CC} = 5.25 \text{ V},$	V <sub>I</sub> = 2.7 V				25	μΑ
I <sub>IL</sub> ‡	$V_{CC} = 5.25 \text{ V},$	V <sub>I</sub> = 0.4 V				-250	μΑ
los§	$V_{CC} = 5.25 \text{ V},$	V <sub>O</sub> = 0.5 V		-30	-70	-130	mA
Icc	V <sub>CC</sub> = 5.25 V,	V <sub>I</sub> = 0,	Outputs open			210	mA
Ci	f = 1 MHz,	V <sub>I</sub> = 2 V			8.5		pF
Co	f = 1 MHz,	V <sub>O</sub> = 2 V			10		pF

<sup>†</sup> All typical values are at  $V_{CC} = 5 \text{ V}$ ,  $T_A = 25^{\circ}\text{C}$ .

### switching characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

PARAMETER	FROM		TO (OUTPUT)	TEST	TIBPAL20	L8-5CFN		.20L8-5CJT .20L8-5CNT	UNIT
	(INPUT)	(OUTPUT)		CONDITIONS	MIN	MAX	MIN	MAX	
	I, I/O	O, I/O	with up to 4 outputs switching		1.5	5	1.5	5	
<sup>t</sup> pd	I, I/O	O, I/O	with more than 4 outputs switching	R1 = 200 Ω, R2 = 200 Ω,	1.5	5	1.5	5.5	ns
t <sub>en</sub>	I, I/O		O, I/O See Figure 8		2	7	2	7	ns
t <sub>dis</sub>	I, I/O		O, I/O		2	7	2	7	ns

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 $<sup>\</sup>ddagger$  I/O leakage is the worst case of IOZL and IIL or IOZH and IIH, respectively.

<sup>§</sup> Not more than one output should be shorted at a time, and the duration of the short circuit should not exceed one second. V<sub>O</sub> is set at 0.5 V to avoid test problems caused by test equipment ground degradation.

#### TIBPAL20R4-5C, TIBPAL20R6-5C HIGH-PERFORMANCE *IMPACT-X*™ *PAL*® CIRCUITS

SRPS010F - D3353, OCTOBER 1989 - REVISED SEPTEMBER 1992

#### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, V <sub>CC</sub> (see Note 1)	7 V
Input voltage (see Note 1)	5.5 V
Voltage applied to disabled output (see Note 1)	5.5 V
Operating free-air temperature range	0°C to 75°C
Storage temperature range	-65°C to 150°C

NOTE 1: These ratings apply except for programming pins during a programming cycle or during a preload cycle.

#### recommended operating conditions

			MIN	NOM	MAX	UNIT
Vcc	Supply voltage		4.75	5	5.25	V
VIH	High-level input voltage (see Note 2)		2		5.5	V
V <sub>IL</sub>	Low-level input voltage (see Note 2)		T		0.8	V
ІОН	High-level output current				-3.2	mA
loL	Low-level output current				24	mA
f <sub>clock</sub>	Clock frequency		0		125	MHz
+	Pulso duration, clock	High	4			ns
τ <sub>W</sub>	Pulse duration, clock		4			113
t <sub>su</sub>	Setup time, input or feedback before clock↑		4.5			ns
th	Hold time, input or feedback after clock↑		0			ns
TA	Operating free-air temperature		0	25	75	°C

NOTE 2: These are absolute voltage levels with respect to the ground pin of the device and include all overshoots due to system and/or tester noise. Testing these parameters should not be attempted without suitable equipment.



# TIBPAL20R4-5C, TIBPAL20R6-5C HIGH-PERFORMANCE $IMPACT-X^{TM}$ $PAL^{\oplus}$ CIRCUITS

SRPS010F - D3353, OCTOBER 1989 - REVISED SEPTEMBER 1992

#### electrical characteristics over recommended operating free-air temperature range

PAR/	AMETER		TEST CONDITIONS		MIN	TYP <sup>†</sup>	MAX	UNIT
VIK		$V_{CC} = 4.75 \text{ V},$	$I_{I} = -18 \text{ mA}$			-0.8	-1.5	V
Vон		$V_{CC} = 4.75 \text{ V},$	$I_{OH} = -3.2 \text{ mA}$		2.4	2.7		V
VOL		$V_{CC} = 4.75 \text{ V},$	$I_{OL} = 24 \text{ mA}$			0.3	0.5	V
l <sub>OZH</sub> ‡		$V_{CC} = 5.25 \text{ V},$	V <sub>O</sub> = 2.7 V				100	μΑ
l <sub>OZL</sub> ‡		$V_{CC} = 5.25 \text{ V},$	V <sub>O</sub> = 0.4 V				-100	μΑ
II		$V_{CC} = 5.25 \text{ V},$	V <sub>I</sub> = 5.5 V				100	μА
I <sub>IH</sub> ‡		V <sub>CC</sub> = 5.25 V,	V <sub>I</sub> = 2.7 V		T		25	μΑ
I <sub>IL</sub> ‡		V <sub>CC</sub> = 5.25 V,	V <sub>I</sub> = 0.4 V		T		-250	μΑ
IOS§		V <sub>CC</sub> = 5.25 V,	V <sub>O</sub> = 0.5 V		-30	-70	-130	mA
Icc		$V_{CC} = 5.25 \text{ V},$	$V_{I} = 0$ ,	Outputs open			210	mA
Ci	1	f = 1 MHz,	V <sub>I</sub> = 2 V			8.5		pF
	CLK/OE	1 – 1 1011 12,	V   - 2 V			7.5		Pi
C	I/O	f = 1 MHz,	V <sub>O</sub> = 2 V			10		pF
Co	Q	1 = 1 IVII1Z,	v () = 2 v			7		ρι-

### switching characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

PARAMETER	FROM TO (OUTPUT)		TEST CONDITIONS	TIBPAL20R4-5CFN TIBPAL20R6-5CFN			TIBPAL20R4-5CJT TIBPAL20R4-5CNT TIBPAL20R6-5CJT TIBPAL20R6-5CNT			UNIT
				MIN	TYP <sup>†</sup>	MAX	MIN	TYP <sup>†</sup>	MAX	
	withou	t feedback		125			125			
f <sub>max</sub> ¶	with internal feedbac	k (counter configuration)		125			125			MHz
	with exter	nal feedback		117			111			
<sup>t</sup> pd	CLK↑	Q		1.5		4	1.5		4.5	ns
<sup>t</sup> pd	CLK↑	Internal feedback	R1 = 200 $\Omega$ ,			3.5			3.5	ns
t <sub>pd</sub>	I, I/O	I/O	$R2 = 200 \Omega$ ,	1.5		5	1.5		5	ns
t <sub>en</sub>	ŌE↓	Q	See Figure 8	1.5		6	1.5		6	ns
<sup>t</sup> dis	ŌE↑	Q		1		6.5	1		7	ns
t <sub>en</sub>	I, I/O	I/O		2		7	2		7	ns
t <sub>dis</sub>	I, I/O	I/O		2		7	2		7	ns
t <sub>r</sub>					1.5			1.5		ns
t <sub>f</sub>					1.5			1.5		ns
tsk(o)#	Skew between	registered outputs			0.5			0.5		ns

 $<sup>^{\</sup>dagger}$  All typical values are at VCC = 5 V, TA = 25°C.



<sup>‡</sup> I/O leakage is the worst case of IOZL and I<sub>IL</sub> or IOZH and I<sub>IH</sub>, respectively.

<sup>§</sup> Not more than one output should be shorted at a time, and the duration of the short circuit should not exceed one second. V<sub>O</sub> is set at 0.5 V to avoid test problems caused by test equipment ground degradation.

 $<sup>\</sup>P$  See 'fmax Specification' near the end of this data sheet.

 $<sup>^{\#}</sup>t_{Sk(0)}$  is the skew time between registered outputs.

# TIBPAL20R8-5C HIGH-PERFORMANCE IMPACT-X imp PAL CIRCUITS

SRPS010F - D3353, OCTOBER 1989 - REVISED SEPTEMBER 1992

#### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, V <sub>CC</sub> (see Note 1)	. 7 V
Input voltage (see Note 1)	5.5 V
Voltage applied to disabled output (see Note 1)	5.5 V
Operating free-air temperature range 0°C to	ა 75°C
Storage temperature range –65°C to	150°C

NOTE 1: These ratings apply except for programming pins during a programming cycle or during a preload cycle.

#### recommended operating conditions

				MIN	NOM	MAX	UNIT
Vcc	Supply voltage			4.75	5	5.25	V
VIH	High-level input voltage (see Note 2)		2		5.5	V	
V <sub>IL</sub>	Low-level input voltage (see Note 2)					0.8	V
ГОН	High-level output current					-3.2	mA
loL	Low-level output current					24	mA
f <sub>clock</sub>	Clock frequency			0		125	MHz
	Dulas duration alask	High		4			ns
t <sub>W</sub>	Pulse duration, clock			4			115
t <sub>su</sub>	Setup time, input or feedback before clock↑			4.5			ns
th	Hold time, input or feedback after clock↑			0			ns
TA	Operating free-air temperature			0	25	75	°C

NOTE 2: These are absolute voltage levels with respect to the ground pin of the device and include all overshoots due to system and/or tester noise. Testing these parameters should not be attempted without suitable equipment.



#### TIBPAL20R8-5C HIGH-PERFORMANCE *IMPACT-X™ PAL®* CIRCUITS

SRPS010F - D3353, OCTOBER 1989 - REVISED SEPTEMBER 1992

#### electrical characteristics over recommended operating free-air temperature range

PARAMETER	TEST CONDITIONS		TIBP	TIBPAL20R8-5CFN			TIBPAL20R8-5CJT TIBPAL20R8-5CNT		
TAKAMETEK	120	TOORDITIONS	MIN	TYP <sup>†</sup>	MAX	MIN	TYP <sup>†</sup>	MAX	UNIT
VIK	$V_{CC} = 4.75 V$ ,	$I_{I} = -18 \text{ mA}$		-0.8	-1.5		-0.8	-1.5	V
VOH	$V_{CC} = 4.75 V$ ,	$I_{OH} = -3.2 \text{ mA}$	2.4	2.7		2.4	2.7		V
V <sub>OL</sub>	$V_{CC} = 4.75 V$ ,	$I_{OL} = 24 \text{ mA}$		0.3	0.5		0.3	0.5	V
lozh	$V_{CC} = 5.25 \text{ V},$	$V_0 = 2.7 \text{ V}$			100			100	μΑ
lozL	$V_{CC} = 5.25 \text{ V},$	$V_0 = 0.4 V$			-100			-100	μΑ
I <sub>I</sub>	$V_{CC} = 5.25 \text{ V},$	V <sub>I</sub> = 5.5 V			100			100	μΑ
lін	$V_{CC} = 5.25 \text{ V},$	$V_{I} = 2.7 V$			25			25	μΑ
I <sub>IL</sub>	$V_{CC} = 5.25 \text{ V},$	V <sub>I</sub> = 0.4 V			-250			-250	μΑ
los <sup>‡</sup>	V <sub>CC</sub> = 5.25 V,	V <sub>O</sub> = 0.5 V	-30	-70	-130	-30	-70	-130	mA
Icc	V <sub>CC</sub> = 5.25 V,	V <sub>I</sub> = 0, Outputs open			210			210	mA
	£ 4 MIL-			8.5			6.5		pF
C <sub>i</sub> CLK/OE	f = 1 MHz,	V <sub>I</sub> = 2 V		7.5			5.5		þΓ
Co	f = 1 MHz,	V <sub>O</sub> = 2 V		10			8		pF

### switching characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

PARAMETER	FROM TO (OUTPUT)			TEST	TIBPAL20R8-5CFN			TIBPAL20R8-5CJT TIBPAL20R8-5CNT			UNIT
				CONDITIONS	MIN	TYP <sup>†</sup>	MAX	MIN	TYP <sup>†</sup>	MAX	
	,	without fe	edback		125			125			MHz
f <sub>max</sub> §	with internal fe	edback (c	counter configuration)		125			125			
	with	h external	feedback		117			111			
	CLK↑	Q	with up to 4 outputs switching	R1 = $200 \Omega$ , R2 = $200 \Omega$ , See Figure 8	1.5		4	1.5		4	ns
<sup>t</sup> pd	CLK↑	Q	with more than 4 outputs switching		1.5		4	1.5		4.5	115
$t_{pd}\P$	CLK↑	In	ternal feedback				3.5			3.5	ns
t <sub>en</sub>	OE↓		Q		1.5		6	1.5		6	ns
t <sub>dis</sub>	ŌE↑		Q		1		6.5	1		7	ns
t <sub>r</sub>		·				1.5	·		1.5		ns
t <sub>f</sub>						1.5			1.5		ns
tsk(o)#	Ske	ew betwee	en outputs			0.5			0.5		ns

<sup>†</sup> All typical values are at  $V_{CC} = 5 \text{ V}$ ,  $T_A = 25^{\circ}\text{C}$ .



<sup>‡</sup> Not more than one output should be shorted at a time, and the duration of the short circuit should not exceed one second. V<sub>O</sub> is set at 0.5 V to avoid test problems caused by test equipment ground degradation.

<sup>§</sup> See 'f<sub>max</sub> Specification' near the end of this data sheet.

This parameter is calculated from the measured f<sub>max</sub> with internal feedback in a counter configuration (see Figure 4 for illustration).

 $<sup>^{\#}</sup>$  t<sub>Sk(0)</sub> is the skew time between registered outputs.

# TIBPAL20L8-7M, TIBPAL20R4-7M, TIBPAL20R6-7M, TIBPAL20R8-7M HIGH-PERFORMANCE *IMPACT-X*™ *PAL*® CIRCUITS

SRPS010F - D3353, OCTOBER 1989 - REVISED SEPTEMBER 1992

#### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, V <sub>CC</sub> (see Note 1)	7 V
Input voltage (see Note 1)	5.5 V
Voltage applied to disabled output (see Note 1)	5.5 V
Operating free-air temperature range	-55°C to 125°C
Storage temperature range	-65°C to 150°C

NOTE 1: These ratings apply except for programming pins during a programming cycle or during a preload cycle.

#### recommended operating conditions

			MIN	NOM	MAX	UNIT
VCC	Supply voltage	4.5	5	5.5	V	
VIH	High-level input voltage (see Note 2)		2		5.5	V
V <sub>IL</sub>	Low-level input voltage (see Note 2)				0.8	V
IOH	High-level output current			-2	mA	
loL	Low-level output current			12	mA	
f <sub>clock</sub> †	Clock frequency	0		100	MHz	
t <sub>W</sub> †	Pulse duration, clock	High	5			ns
	Fulse duration, clock	5			7 '''	
t <sub>su</sub> †	Setup time, input or feedback before clock↑	7			ns	
t <sub>h</sub> †	Hold time, input or feedback after clock↑	0			ns	
T <sub>A</sub>	Operating free-air temperature	<del>-</del> 55	25	125	°C	

 $^{\dagger}\,\mathrm{f}_{\mathrm{clock}},\,\mathrm{t}_{\mathrm{W}},\,\mathrm{t}_{\mathrm{SU}},\,\mathrm{and}\;\mathrm{t}_{\mathrm{h}}$  do not apply to TIBPAL16L8'

NOTE 2: These are absolute voltage levels with respect to the ground pin of the device and include all overshoots due to system and/or tester noise. Testing these parameters should not be attempted without suitable equipment.



# TIBPAL20L8-7M, TIBPAL20R4-7M, TIBPAL20R6-7M, TIBPAL20R8-7M HIGH-PERFORMANCE IMPACT-X™ PAL® CIRCUITS

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#### electrical characteristics over recommended operating free-air temperature range

PARAMETER			TEST CONDITIONS		MIN	TYP <sup>†</sup>	MAX	UNIT	
VIK		V <sub>CC</sub> = 4.5 V,	I <sub>I</sub> = –18 mA			-0.8	-1.5	V	
VOH		V <sub>CC</sub> = 4.5 V,	I <sub>OH</sub> = −2 mA		2.4	2.7		V	
VOL		$V_{CC} = 4.5 \text{ V},$	I <sub>OL</sub> = 12 mA			0.25	0.5	V	
lozh	0, Q outputs	V <sub>CC</sub> = 5.5 V,	V- 27V				20		
IOZH	I/O ports	VCC = 5.5 V,	$V_0 = 2.7 \text{ V}$			100	μΑ		
lozL	0, Q outputs	V <sub>CC</sub> = 5.5 V,	V <sub>O</sub> = 0.4 V				-20	μА	
I.OZL	I/O ports	VCC = 0.0 1,	VO = 0.4 V			-250	μΛ		
Ц		$V_{CC} = 5.5 \text{ V},$	V <sub>I</sub> = 5.5 V				1	mA	
Iн	I/O ports	V <sub>CC</sub> = 5.5 V,	V <sub>I</sub> = 2.7 V				100	μΑ	
יור	All others	VCC = 0.0 V,	V   - 2.7 V			25	μΑ		
I <sub>IL</sub>		$V_{CC} = 5.5 \text{ V},$	V <sub>I</sub> = 0.4 V				-250	μΑ	
los‡		$V_{CC} = 5.5 V$ ,	V <sub>O</sub> = 0.5 V		-30	-70	-130	mA	
Icc		V <sub>CC</sub> = 5.5 V,	$V_I = GND$ , $\overline{OE} = V_{IH}$ ,	Outputs open			220	mA	
Ci	I	f = 1 MHz,	V <sub>I</sub> = 2 V			8.5		pF	
	CLK/OE	1 – 1 1411 12,	v   - 2 v		7.5	·	۲'		
Co		f = 1 MHz,	V <sub>O</sub> = 2 V			10		pF	

<sup>&</sup>lt;sup>†</sup> All typical values are at  $V_{CC} = 5 \text{ V}$ ,  $T_A = 25^{\circ}\text{C}$ .

### switching characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITION	MIN	MAX	UNIT
	without f	eedback		100		
f <sub>max</sub> §	with interna (counter co	al feedback nfiguration)		100		MHz
	with externa	al feedback	R1 = 390 $\Omega$ ,	74		
<sup>t</sup> pd	I, I/O	O, I/O	$R2 = 750 \Omega$ ,	1	7	ns
t <sub>pd</sub>	CLK	Q	See Figure 8	1	7	ns
t <sub>en</sub>	OE↓	Q	1	1	8	ns
<sup>t</sup> dis	OE↑	Q	]	1	10	ns
<sup>t</sup> en	I, I/O	O, I/O	]	1	9	ns
t <sub>dis</sub>	I, I/O	O, I/O	1	1	10	ns

 $<sup>\</sup>S$  See 'f<sub>max</sub> Specification' near the end of this data sheet. f<sub>max</sub> does not apply for TIBPAL20L8'. f<sub>max</sub> with external feedback is not production tested and is calculated from the equation found in the f<sub>max</sub> specifications section.



<sup>&</sup>lt;sup>‡</sup> Not more than one output should be shorted at a time, and the duration of the short circuit should not exceed one second. V<sub>O</sub> is set at 0.5 V to avoid test problems caused by test equipment ground degradation.

TIBPAL20L8-5C, TIBPAL20R4-5C, TIBPAL20R6-5C, TIBPAL20R8-5C TIBPAL20L8-7M, TIBPAL20R4-7M, TIBPAL20R6-7M, TIBPAL20R8-7M HIGH-PERFORMANCE *IMPACT-X™ PAL®* CIRCUITS

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#### programming information

Texas Instruments programmable logic devices can be programmed using widely available software and inexpensive device programmers.

Complete programming specifications, algorithms, and the latest information on hardware, software, and firmware are available upon request. Information on programmers capable of programming Texas Instruments programmable logic is also available, upon request, from the nearest TI field sales office, local authorized TI distributor, or by calling Texas Instruments at (214) 997-5666.

#### asynchronous preload procedure for registered outputs (see Figure 1 and Note 3)

The output registers can be preloaded to any desired state during device testing. This permits any state to be tested without having to step through the entire state-machine sequence. Each register is preloaded individually by following the steps given below.

- Step 1. With V<sub>CC</sub> at 5 volts and Pin 1 at V<sub>II</sub>, raise Pin 13 to V<sub>IHH</sub>.
- Step 2. Apply either V<sub>II</sub> or V<sub>IH</sub> to the output corresponding to the register to be preloaded.
- Step 3. Lower Pin 13 to 5 V.
- Step 4. Remove output voltage, then lower Pin 13 to  $V_{IL}$ . Preload can be verified by observing the voltage level at the output pin.

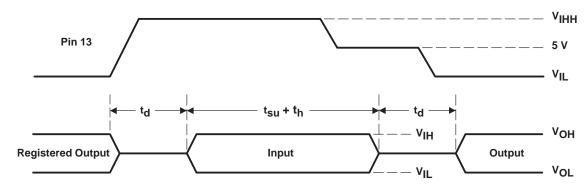


Figure 1. Asynchronous Preload Waveforms

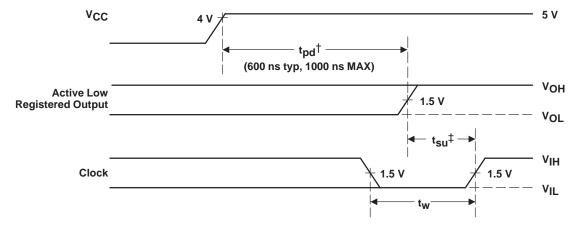
NOTE 3:  $t_d = t_{SU} = t_h = 100 \text{ ns to } 1000 \text{ ns}, V_{IHH} = 10.25 \text{ V to } 10.75 \text{ V}$ 

TIBPAL20L8-5C, TIBPAL20R4-5C, TIBPAL20R6-5C, TIBPAL20R8-5C TIBPAL20L8-7M, TIBPAL20R4-7M, TIBPAL20R6-7M, TIBPAL20R8-7M HIGH-PERFORMANCE IMPACT-X™ PAL® CIRCUITS

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#### power-up reset, see Figure 2

Following power up, all registers are reset to zero. This feature provides extra flexibility to the system designer and is especially valuable in simplifying state-machine initialization. To ensure a valid power-up reset, it is important that the rise of  $V_{CC}$  be monotonic. Following power-up reset, a low-to-high clock transition must not occur until all applicable input and feedback setup times are met.



<sup>†</sup> This is the power-up reset time and applies to registered outputs only. The values shown are from characterization data.

Figure 2. Power-Up Reset Waveforms

<sup>&</sup>lt;sup>‡</sup>This is the setup time for input or feedback.

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#### fmax SPECIFICATIONS

#### f<sub>max</sub> without feedback, see Figure 3

In this mode, data is presented at the input to the flip-flop and clocked through to the Q output with no feedback. Under this condition, the clock period is limited by the sum of the data setup time and the data hold time ( $t_{su} + t_h$ ). However, the minimum fmax is determined by the minimum clock period ( $t_w$  high +  $t_w$  low).

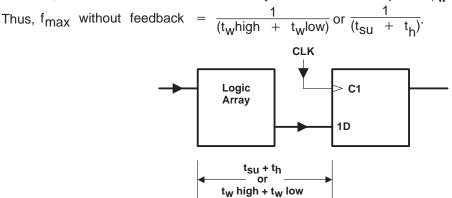


Figure 3. f<sub>max</sub> Without Feedback

#### f<sub>max</sub> with internal feedback, see Figure 4

This configuration is most popular in counters and on-chip state-machine designs. The flip-flop inputs are defined by the device inputs and flip-flop outputs. Under this condition, the period is limited by the internal delay from the flip-flop outputs through the internal feedback and logic array to the inputs of the next flip-flop.

Thus, 
$$f_{max}$$
 with internal feedback =  $\frac{1}{(t_{su} + t_{pd} CLK - to - FB)}$ .

Where tpd CLK-to-FB is the deduced value of the delay from CLK to the input of the logic array.

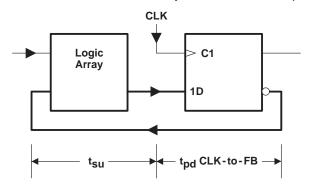


Figure 4. f<sub>max</sub> With Internal Feedback

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#### fmax SPECIFICATIONS

#### f<sub>max</sub> with external feedback, see Figure 5

This configuration is a typical state-machine design with feedback signals sent off-chip. This external feedback could go back to the device inputs or to a second device in a multi-chip state machine. The slowest path defining the period is the sum of the clock-to-output time and the input setup time for the external signals  $(t_{su} + t_{pd} CLK-to-Q)$ .

Thus,  $f_{max}$  with external feedback =  $\frac{1}{(t_{su} + t_{pd} CLK - to - Q)}$ .

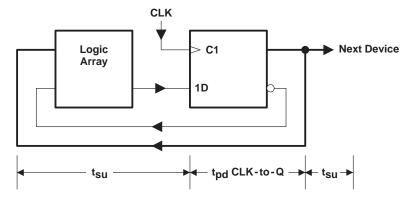


Figure 5. f<sub>max</sub> With External Feedback

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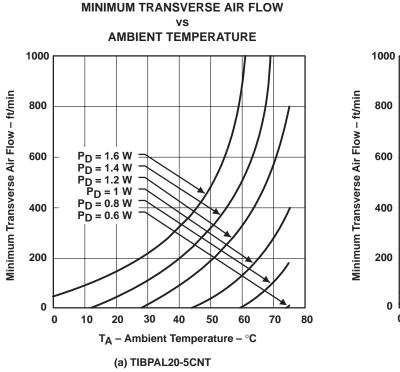
#### THERMAL INFORMATION

#### thermal management of the TIBPAL20R8-5C

Thermal management of the TIBPAL20R8-5CNT and TIBPAL20R8-5CFN is necessary when operating at certain conditions of frequency, output loading, and outputs switching simultaneously. The device and system application will determine the appropriate level of management.

Determining the level of thermal management is based on factors such as power dissipation  $(P_D)$ , ambient temperature  $(T_A)$ , and transverse airflow (FPM). Figures 6 (a) and 6 (b) show the relationship between ambient temperature and transverse airflow at given power dissipation levels. The required transverse airflow can be determined at a particular ambient temperature and device power dissipation level in order to ensure the device specifications.

Figure 7 illustrates how power dissipation varies as a function of frequency and the number of outputs switching simultaneously. It should be noted that all outputs are fully loaded ( $C_L = 50 \, \text{pF}$ ). Since the condition of eight fully loaded outputs represents the worst-case condition, each application must be evaluated accordingly.



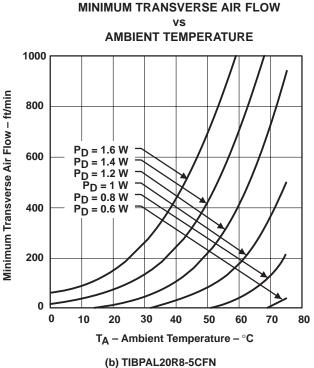


Figure 6

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#### THERMAL INFORMATION

# POWER DISSIPATION vs

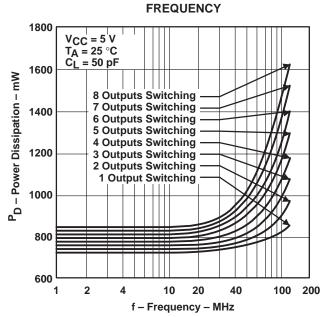
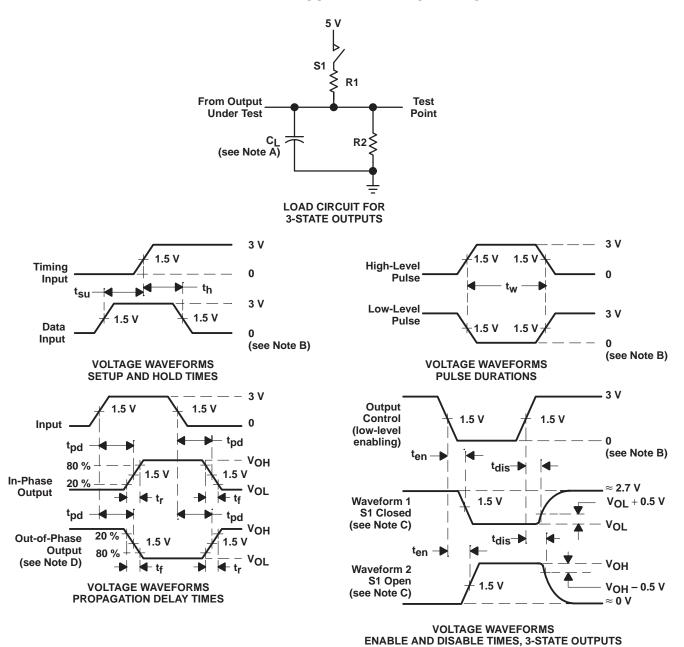


Figure 7

TIBPAL20L8-5C, TIBPAL20R4-5C, TIBPAL20R6-5C, TIBPAL20R8-5C TIBPAL20L8-7M, TIBPAL20R4-7M, TIBPAL20R6-7M, TIBPAL20R8-7M HIGH-PERFORMANCE  $IMPACT-X^{TM}$   $PAL^{\circledR}$  CIRCUITS

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#### PARAMETER MEASUREMENT INFORMATION



NOTES: A.  $C_L$  includes probe and jig capacitance and is 50 pF for  $t_{pd}$  and  $t_{en}$ , 5 pF for  $t_{dis}$ .

- B. All input pulses have the following characteristics: For C suffix, PRR  $\leq$  1 MHz,  $t_{\Gamma} = t_{f} = 2$  ns, duty cycle = 50%; For M suffix, PRR  $\leq$  10 MHz,  $t_{\Gamma} = t_{f} \leq$  2 ns, duty cycle = 50%
- C. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- D. When measuring propagation delay times of 3-state outputs, switch S1 is closed.
- E. Equivalent loads may be used for testing.

Figure 8. Load Circuit and Voltage Waveforms



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#### metastable characteristics of TIBPAL20R4-5C, TIBPAL20R6-5C, and TIBPAL20R8-5C

At some point a system designer is faced with the problem of synchronizing two digital signals operating at two different frequencies. This problem is typically overcome by synchronizing one of the signals to the local clock through use of a flip-flop. However, this solution presents an awkward dilemma since the setup and hold time specifications associated with the flip-flop are sure to be violated. The metastable characteristics of the flip-flop can influence overall system reliability.

Whenever the setup and hold times of a flip-flop are violated, its output response becomes uncertain and is said to be in the metastable state if the output hangs up in the region between  $V_{IL}$  and  $V_{IH}$ . This metastable condition lasts until the flip-flop falls into one of its two stable states, which takes longer than the specified maximum propagation delay time (CLK to Q max).

From a system engineering standpoint, a designer cannot use the specified data sheet maximum for propagation delay time when using the flip-flop as a data synchronizer – how long to wait after the specified data sheet maximum must be known before using the data in order to guarantee reliable system operation.

The circuit shown in Figure 9 can be used to evaluate MTBF (Mean Time Between Failure) and  $\Delta t$  for a selected flip-flop. Whenever the Q output of the DUT is between 0.8 V and 2 V, the comparators are in opposite states. When the Q output of the DUT is higher than 2 V or lower than 0.8 V, the comparators are at the same logic level. The outputs of the two comparators are sampled a selected time ( $\Delta t$ ) after SCLK. The exclusive OR gate detects the occurrence of a failure and increments the failure counter.

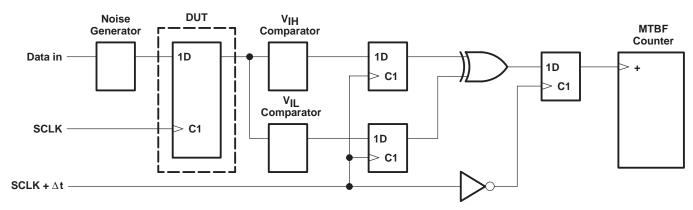


Figure 9. Metastable Evaluation Test Circuit

In order to maximize the possibility of forcing the DUT into a metastable state, the input data signal is applied so that it always violates the setup and hold time. This condition is illustrated in the timing diagram in Figure 10. Any other relationship of SCLK to data will provide less chance for the device to enter into the metastable state.

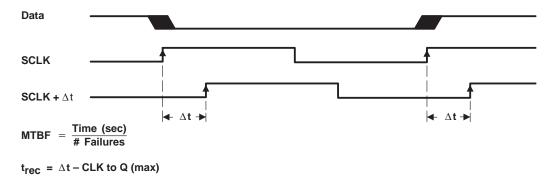


Figure 10. Timing Diagram



# TIBPAL20R4-5C, TIBPAL20R6-5C, TIBPAL20R8-5C HIGH-PERFORMANCE *IMPACT-X* ™ *PAL*® CIRCUITS

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By using the described test circuit, MTBF can be determined for several different values of  $\Delta t$  (see Figure 9). Plotting this information on semilog scale demonstrates the metastable characteristics of the selected flip-flop. Figure 11 shows the results for the TIBPAL20'-5C operating at 1 MHz.

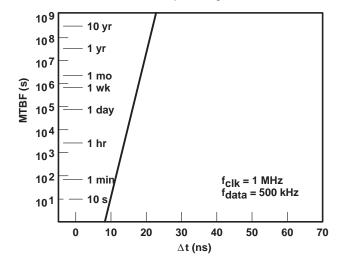


Figure 11. Metastable Characteristics

From the data taken in the above experiment, an equation can be derived for the metastable characteristics at other clock frequencies.

The metastable equation: 
$$\frac{1}{MTBF} = f_{SCLK} \times f_{data} \times C1 e^{(-C2 \times \Delta t)}$$

The constants C1 and C2 describe the metastable characteristics of the device. From the experimental data, these constants can be solved for:  $C1 = 4.37 \times 10^{-3}$  and C2 = 2.01

Therefore

$$\frac{1}{\text{MTBF}} = f_{\text{SCLK}} \times f_{\text{data}} \times 4.37 \times 10^{-3} \text{ e}^{(-2.01 \times \Delta t)}$$

#### definition of variables

DUT (Device Under Test): The DUT is a 5-ns registered PLD programmed with the equation Q : = D.

MTBF (Mean Time Between Failures): The average time (s) between metastable occurrences that cause a violation of the device specifications.

fSCLK (system clock frequency): Actual clock frequency for the DUT.

f<sub>data</sub> (data frequency): Actual data frequency for a specified input to the DUT.

C1: Calculated constant that defines the magnitude of the curve.

C2: Calculated constant that defines the slope of the curve.

 $t_{rec}$  (metastability recovery time): Minimum time required to guarantee recovery from metastability, at a given MTBF failure rate.  $t_{rec} = \Delta t - t_{pd}$  (CLK to Q, max)

Δt: The time difference (ns) from when the synchronizing flip-flop is clocked to when its output is sampled.

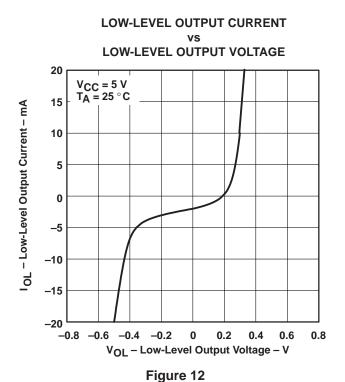
The test described above has shown the metastable characteristics of the TIBPAL20R4/R6/R8-5C series. For additional information on metastable characteristics of Texas Instruments logic circuits, please refer to TI Applications publication SDAA004, "Metastable Characteristics, Design Considerations for ALS, AS, and LS Circuits."



TIBPAL20L8-5C, TIBPAL20R4-5C, TIBPAL20R6-5C, TIBPAL20R8-5C TIBPAL20L8-7M, TIBPAL20R4-7M, TIBPAL20R6-7M, TIBPAL20R8-7M HIGH-PERFORMANCE IMPACT-X™ PAL® CIRCUITS

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#### TYPICAL CHARACTERISTICS



HIGH-LEVEL OUTPUT CURRENT vs
HIGH-LEVEL OUTPUT VOLTAGE

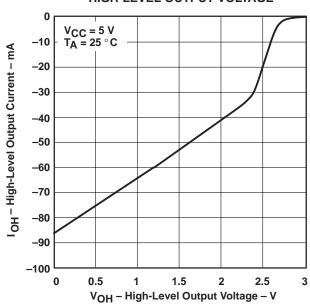
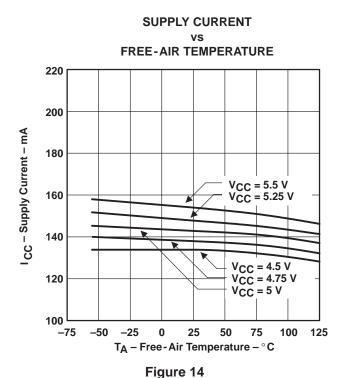


Figure 13







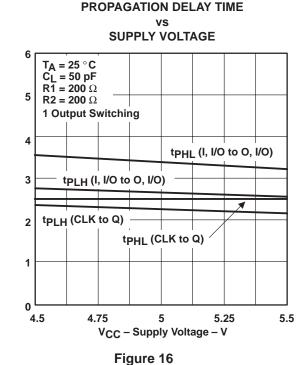
TIBPAL20L8-5C, TIBPAL20R4-5C, TIBPAL20R6-5C, TIBPAL20R8-5C TIBPAL20L8-7M, TIBPAL20R4-7M, TIBPAL20R6-7M, TIBPAL20R8-7M HIGH-PERFORMANCE *IMPACT-X™ PAL®* CIRCUITS

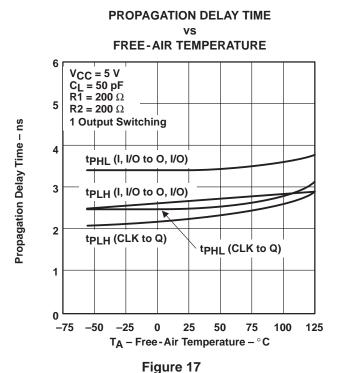
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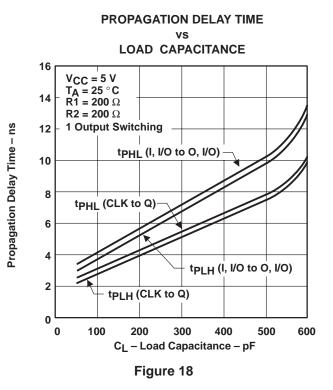
#### TYPICAL CHARACTERISTICS

Propagation Delay Time - ns

#### **POWER DISSIPATION FREQUENCY 8-BIT COUNTER MODE** 1100 $V_{CC} = 5 V$ P<sub>D</sub> - Power Dissipation - mW $T_A = 80 \, ^{\circ} C$ 1000 $T_A = 25 \, ^{\circ}C$ 900 $T_A = 0 \circ C$ $T_A = 0 \circ C$ $T_A = 80 \, ^{\circ}C$ 800 700 2 20 40 200 10 100 f - Frequency - MHz Figure 15







TIBPAL20L8-5C, TIBPAL20R4-5C, TIBPAL20R6-5C, TIBPAL20R8-5C TIBPAL20L8-7M, TIBPAL20R4-7M, TIBPAL20R6-7M, TIBPAL20R8-7M HIGH-PERFORMANCE *IMPACT-X*™ *PAL*® CIRCUITS

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#### TYPICAL CHARACTERISTICS

Propagation Delay Time - ns

#### **SKEW BETWEEN OUTPUTS** NUMBER OF OUTPUTS SWITCHING 0.8 tsk(o) - Skew Between Outputs Switching - ns $V_{CC} = 5 V$ $T_A = 25 \,^{\circ}C$ R1 = 200 $\Omega$ 0.7 $R2 = 200 \Omega$ $C_L = 50 pF$ 0.6 8-Bit Counter 0.5 0.4 **Outputs Switching in the Opposite Direction** 0.3 0.2 0.1 **Outputs Switching in the Same Direction** 0 2 8 **Number of Outputs Switching**

**PROPAGATION DELAY TIME** NUMBER OF OUTPUTS SWITCHING  $V_{CC} = 5 V$ TA = 25 ° C  $C_L = 50 pF$ 5  $R1 = 200 \Omega$  $R2 = 200 \Omega$ 3 2  $\Delta = t_{PHL} (I, I/O to O, I/O)$ ▲ = tplH (I, I/O to O, I/O) 1 o = tpHL (CLK to Q) • = tpLH (CLK to Q) 0

Figure 19

Figure 20

**Number of Outputs Switching** 

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ARIZONA: Anthem (602) 966-6600; Arrow/Schweber (602) 437-0750; Hall-Mark (602) 431-0030; Marshall (602) 496-0290; Wyle (602) 437-2088.

CALIFORNIA: Los Angeles/Orange County: Anthem (818) 775-1333, (714) 768-4444; Arrow/Schweber (818) 380-9686, (714) 838-5422; Hall-Mark (818) 773-4500, (714) 727-6000; Marshall (818) 878-7000, (714) 458-5301; Wyle (818) 880-9900, (714) 863-9953; Zeus (714) 921-9000, (818) 889-3838:

(619) 669-3636, Sacramento: Anthem (916) 624-9744; Hall-Mark (916) 624-9781; Marshall (916) 635-9700; Wyle (916) 638-5282; San Diego: Anthem (619) 453-9005; Arrow/Schweber (619) 565-4800; Hall-Mark (619) 268-1201; Marshall (619) 578-9600; Wyle (619) 565-9171; Zeus (619) 277-9681.

San Francisco Bay Area: Anthem (408) 453-1200; Arrow/Schweber (408) 441-9700, (510) 490-9477; Hall-Mark (408) 432-4000; Marshall (408) 942-4600; With (409) 377-350-750-750-750-750 Wyle (408) 727-2500; Zeus (408) 629-4789.

**COLORADO:** Anthem (303) 790-4500; Arrow/Schweber (303) 799-0258; Hall-Mark (303) 790-1662; Marshall (303) 451-8383; Wyle (303) 457-9953.

CONNECTICUT: Anthem (203) 575-1575; Arrow/Schweber (203) 265-7741; Hall-Mark (203) 271-2844; Marshall (203) 265-3822.

**FLORIDA: Fort Lauderdale:** Arrow/Schweber (305) 429-8200; Halll-Mark (305) 971-9280; Marshall (305)

**Orlando:** Arrow/Schweber (407) 333-9300; Hall-Mark (407) 830-5855; Marshall (407) 767-8585; Zeus (407) 788-9100. Tampa: Hall-Mark (813) 541-7440; Marshall (813) 573-1399.

**GEORGIA:** Arrow/Schweber (404) 497-1300; Hall-Mark (404) 623-4400; Marshall (404) 923-5750.

ILLINOIS: Anthem (708) 884-0200; Arrow/Schweber (708) 250-0500; Hall-Mark (312) 860-3800; Marshall (708) 490-0155; Newark (312)784-5100.

INDIANA: Arrow/Schweber (317) 299-2071; Hall-Mark (317) 872-8875; Marshall (317) 297-0483. IOWA: Arrow/Schweber (319) 395-7230.

KANSAS: Arrow/Schweber (913) 541-9542; Hall-Mark (913) 888-4747; Marshall (913) 492-3121.

MARYLAND: Anthem (301) 995-6640; Arrow/Schweber (301) 596-7800; Hall-Mark (301) 988-9800; Marshall (301) 622-1118; Zeus (301) 997-1118.

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MISSOURI: Arrow/Schweber (314) 567-6888; Hall-Mark (314) 291-5350; Marshall (314) 291-4650.

NEW JERSEY: Anthem (201) 227-7960; Arrow/Schweber (201) 227-7860, (609) 596-8000; Hall-Mark (201) 515-3000, (609) 235-1900; Marshall (201) 882-0320, (609) 234-9100. NEW MEXICO: Alliance (505) 292-3360.

NEW YORK: Long Island: Anthem (516) 864-6600; NEW YORK: Long Island: Anthem (516) 864-6600; Arrow/Schweber (516) 231-1000; Hall-Mark (516) 737-0600; Marshall (516) 273-2424; Zeus (914) 937-7400. Rochester: Arrow/Schweber (716) 427-0300; Hall-Mark (716) 425-3300; Marshall (716) 235-7620.

Syracuse: Marshall (607) 785-2345.

Syracuse: Marsnail (607) r00-2545.

NORTH CAROLINA: Arrow/Schweber (919) 876-3132;
Hall-Mark (919) 872-0712; Marshall (919) 878-9882.

OHIO: Cleveland: Arrow/Schweber (216) 248-3990;
Hall-Mark (216) 349-4632; Marshall (216) 248-1788.

Columbus: Hall-Mark (614) 888-3313.

Dayton: Arrow/Schweber (513) 435-5563; Marshall (513) 898-4480; Zeus (513) 293-6162.

OKLAHOMA: Arrow/Schweber (918) 252-7537; Hall-Mark

**OREGON:** Almac/Arrow (503) 629-8090; Anthem (503) 643-1114; Marshall (503) 644-5050; Wyle (503) 643-7900.

PENNSYLVANIA: Anthem (215) 443-5150;
Arrow/Schweber (215) 928-1800; GRS (215) 922-7037;
(609) 964-8560; Marshall (412) 788-0441.
TEXAS: Austin: Arrow/Schweber (512) 835-4180;
Hall-Mark (512) 258-8848; Marshall (512) 837-1991; Wyle (512) 345-8853;

**Dallas:** Anthem (214) 238-7100; Arrow/Schweber (214) 380-6464; Hall-Mark (214) 553-4300; Marshall (214) 233-5200; Wyle (214) 235-9953; Zeus (214) 783-7010; Houston: Arrow/Schweber (713) 530-4700; Hall-Mark (713) 781-6100; Marshall (713) 467-1666; Wyle (713) 879-9953.

UTAH: Anthem (801) 973-8555; Arrow/Schweber (801) 973-6913; Marshall (801) 973-2288; Wyle (801) 974-9953. WASHINGTON: Almac/Arrow (206) 643-9992, Anthem (206) 483-1700; Marshall (206) 486-5747; Wyle (206) 881-1150.

**WISCONSIN:** Arrow/Schweber (414) 792-0150; Hall-Mark (414) 797-7844; Marshall (414) 797-8400.

CANADA: Calgary: Future (403) 235-5325;

Edmonton: Future (403) 438-2858;

**Montreal:** Arrow/Schweber (514) 421-7411; Future (514) 694-7710; Marshall (514) 694-8142

Ottawa: Arrow/Schweber (613) 226-6903; Future (613) 820-8313

Quebec: Future (418) 897-6666.

**Toronto:** Arrow/Schweber (416) 670-7769; Future (416) 612-9200; Marshall (416) 458-8046. Vancouver: Arrow/Schweber (604) 421-2333; Future (604) 294-1166.

#### **TI Die Processors**

Chip Supply (407) 298-7100 Elmo Semiconductor (818) 768-7400 Minco Technology Labs (512) 834-2022



D0892





11-Apr-2013

#### **PACKAGING INFORMATION**

Orderable Device	Status	Package Type	•	Pins	_	Eco Plan	Lead/Ball Finish	MSL Peak Temp	Op Temp (°C)	Top-Side Markings	Samples
	(1)		Drawing		Qty	(2)		(3)		(4)	
5962-87671193A	OBSOLETE	LCCC	FK	28		TBD	Call TI	Call TI	-55 to 125		
5962-8767119KA	OBSOLETE	CFP	W	24		TBD	Call TI	Call TI	-55 to 125		
5962-8767119LA	OBSOLETE	CDIP	JT	24		TBD	Call TI	Call TI	-55 to 125		
TIBPAL20L8-5CFN	ACTIVE	PLCC	FN	28	37	TBD	CU	Level-1-220C-UNLIM	0 to 75	20L8-5CFN	Samples
TIBPAL20L8-5CNT	ACTIVE	PDIP	NT	24	15	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type	0 to 75	TIBPAL20L8-5CN T	Samples
TIBPAL20R4-5CFN	OBSOLETE	PLCC	FN	28		TBD	Call TI	Call TI	0 to 75		
TIBPAL20R4-5CNT	OBSOLETE	PDIP	NT	24		TBD	Call TI	Call TI	0 to 75		
TIBPAL20R6-5CFN	OBSOLETE	PLCC	FN	28		TBD	Call TI	Call TI	0 to 75	20R6-5CFN	
TIBPAL20R6-5CNT	OBSOLETE	PDIP	NT	24		TBD	Call TI	Call TI	0 to 75	TIBPAL20R6-5CN T	
TIBPAL20R8-5CFN	OBSOLETE	PLCC	FN	28		TBD	Call TI	Call TI	0 to 75		
TIBPAL20R8-5CNT	OBSOLETE	PDIP	NT	24		TBD	Call TI	Call TI	0 to 75		
TIBPAL20R8-7MFKB	OBSOLETE	LCCC	FK	28		TBD	Call TI	Call TI	-55 to 125	5962- 87671193A TIBPAL20 R8-7MFKB	
TIBPAL20R8-7MJTB	OBSOLETE	CDIP	JT	24		TBD	Call TI	Call TI	-55 to 125	5962-8767119LA TIBPAL20R8-7MJ TB	
TIBPAL20R8-7MWB	OBSOLETE	CFP	W	24		TBD	Call TI	Call TI	-55 to 125	5962-8767119KA TIBPAL20R8-7MW B	

<sup>(1)</sup> The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW**: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

<sup>(2)</sup> Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.



#### PACKAGE OPTION ADDENDUM

11-Apr-2013

**Pb-Free** (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes. **Pb-Free** (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) Multiple Top-Side Markings will be inside parentheses. Only one Top-Side Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Top-Side Marking for that device.

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#### JT (R-GDIP-T\*\*)

#### 24 LEADS SHOWN

#### **CERAMIC DUAL-IN-LINE**

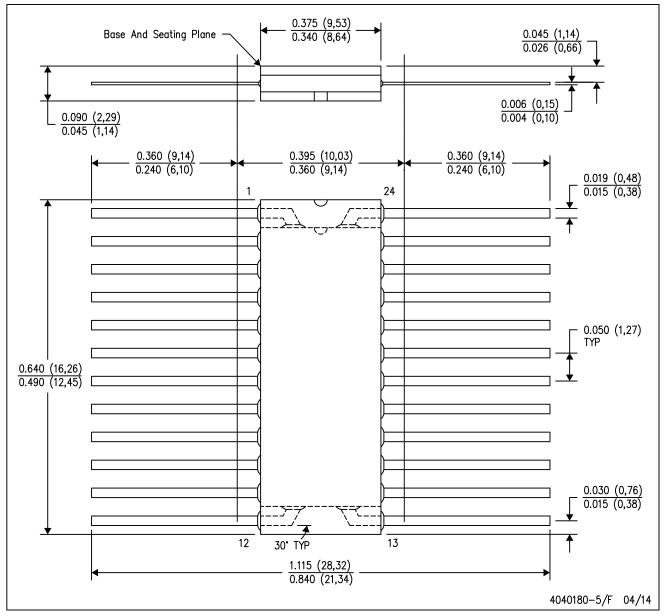


NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification.
- E. Falls within MIL STD 1835 GDIP3-T24, GDIP4-T28, and JEDEC MO-058 AA, MO-058 AB

#### W (R-GDFP-F24)

#### CERAMIC DUAL FLATPACK



NOTES:

- A. All linear dimensions are in inches (millimeters).
- This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only. E. Falls within Mil—Std 1835 GDFP2—F20



#### FK (S-CQCC-N\*\*)

#### LEADLESS CERAMIC CHIP CARRIER

28 TERMINAL SHOWN



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a metal lid.
- D. Falls within JEDEC MS-004



#### NT (R-PDIP-T\*\*)

#### PLASTIC DUAL-IN-LINE PACKAGE

24 PINS SHOWN



NOTES: A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.

B. This drawing is subject to change without notice.

The 28 pin end lead shoulder width is a vendor option, either half or full width.



#### FN (S-PQCC-J\*\*)

#### 20 PIN SHOWN

#### PLASTIC J-LEADED CHIP CARRIER



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. Falls within JEDEC MS-018



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